Product data sheet Characteristics

XBTGK2330

advanced touchscreen panel with keyboard - 320 x 240 pixels QVGA- 5.7" - TFT LCD



Main

Touch consitius rose	4024 v 4024
Complementary	
Cut-out dimensions	209 (+/- 0.4) x 243 (+/- 0.4) mm
Resistance to electrostatic discharge	4 kV conforming to IEC 61000-4-2 level 3
	1USB type A master port (V1.1), compatible with Modicon M340 terminal port communication male SUB-D 9 connector COM1 serial link with RS232C/RS422/RS485 interface at <= 115.2 kbits/s removable screw terminal block connector power supply RJ45 connector Ethernet TCP/IP
Integrated connection type	RJ45 connector COM2 serial link with RS485 interface at <= 187.5 kbit/s, compatible with Siemens MPI (187.5 kbits/s)
Memory description	512 kB SRAM back up of data with lithium battery back-up 16 MB flash EPROM application memory
Processor frequency	133 MHz
Processor name	CPU RISC
Operating system	Magelis
Software designation	Vijeo Designer
Software type	Configuration software
Display size	5.7 inch
Display resolution	320 x 240 pixels QVGA
Display colour	65536 colours
Display type	Backlit colour TFT LCD
Product or component type	Advanced touchscreen panel with keyboard
Range of product	Magelis XBTGK
Main	

Complementary

Complementary		
Touch sensitive zone	1024 x 1024	
Touch panel	Analogue	
Backlight lifespan	50000 hours	
Brightness	8 levels via touch panel	<u></u>
Character font	Japanese (ANK, Kanji) Korean ASCII (European characters) Chinese (simplified Chinese) Taiwanese (traditional Chinese)	normanitation is not
[Us] rated supply voltage	24 V DC	<u> </u>
Supply	External source	
Supply voltage limits	19.228.8 V	

Inrush current	30 A
Power consumption in W	26 W
Number of dynamic function keys symb	14 with LED
Number of static function keys	10 with LED and labels
Number of SERVICE keys	8
Number of alphanumeric keys	12
Local signalling	1 LED (green or orange)normal operation or backlighting faulty:
Number of pages	Limited by internal memory capacity
Downloadable protocols	Telemecanique Modicon FIPWAY Telemecanique Modicon Modbus Plus Telemecanique Modicon Modbus TCP Telemecanique Modicon Modbus Mitsubishi Melsec third party protocols Omron Sysmac third party protocols Rockwell Automation Allen-Bradley third party protocols Siemens Simatic third party protocols Telemecanique Modicon Uni-TE
Realtime clock	Built-in
Data storage equipment	1 Compact Flash card >= 1 GB
Use of slot	For 1 fieldbus communication card (Device Net, Profibus DP)
Port Ethernet	10BASE-T/100BASE-TX
Product mounting	Flush mounting
Fixing mode	By 4 screw clamps By 10 spring clips
Front material	Aluminium alloy
Enclosure material	PPT
Marking	CE
Width	220.3 mm
Height	265 mm
Depth	60.3 mm

Environment

Immunity to microbreaks	5 ms
Standards	UL 508 UL 1604 CSA C22.2 No 14 IEC 61000-6-2 FCC Class A EN 61131-2
Product certifications	CSA Class 1 Division 2 T4A CULus UL Class 1 Division 2 T4A CSA Class 1 Division 2 T5 UL Class 1 Division 2 T5 C-Tick
Ambient air temperature for operation	050 °C
Ambient air temperature for storage	-2060 °C
Relative humidity	090 % without condensation
Operating altitude	< 2000 m
IP degree of protection	IP20 (rear panel) conforming to IEC 60529 IP65 (front panel) conforming to IEC 60529
NEMA degree of protection	NEMA 4X front panel (indoor use)
Shock resistance	15 gn for 11 ms conforming to IEC 60068-2-27
Vibration resistance	1 gn conforming to IEC 60068-2-6 (f = 9150 Hz) 3.5 mm conforming to IEC 60068-2-6 (f = 59 Hz)
Resistance to electromagnetic fields	10 V/m conforming to IEC 61000-4-3
Resistance to fast transients	2 kV conforming to IEC 61000-4-4 level 3

Warranty

18 months

XBTGK2330 is replaced by:



Keypad Panels HMIGK2310

Keypad-touchscreen panel color - 320 x 240 pixels QVGA- 5.7" - TFT LCD Qty 1

Reason for Substitution: End of life | Substitution date: 09 January 2016